In the claims.

Please amend the claims as follows:

- 1. (currently amended) A maskless lithography system comprising an array of focusing elements, each of which focuses [an energy] a photon beam from an array of photon sources into an array of focal spots on an adjacent substrate in order to create a permanent pattern on [an] the adjacent substrate.
- 2. (original) The maskless lithography system as claimed in claim 1, wherein said array of sources includes an array of light emitting diodes.
- 3. (original) The maskless lithography system as claimed in claim 1, wherein said array of sources includes an array of semiconductor lasers.
- 4. (original) The maskless lithography system as claimed in claim 1, wherein said array of sources includes an array of vertical cavity surface emitting lasers.
- 5. (original) The maskless lithography system as claimed in claim 1, wherein said array of focusing elements includes an array of diffractive elements.
- 6. (original) The maskless lithography system as claimed in claim 1, wherein said array of focusing elements includes an array of Fresnel lenses.
- 7. (original) The maskless lithography system as claimed in claim 1, wherein said system further includes an array of microlenses interposed between said array of sources and said array of focusing elements.
- 8. (currently amended) A maskless lithography system comprising an array of focusing

elements, an array of microlenses, and an array of [energy] photon sources, wherein each photon energy source is positioned to selectively direct energy through a microlens toward a focusing element, and each focusing element is positioned to direct a focused beam [toward] onto a substrate to create a permanent pattern thereon.

- 9. (original) The maskless lithography system as claimed in claim 8, wherein said array of sources includes an array of light emitting diodes.
- 10. (original) The maskless lithography system as claimed in claim 8, wherein said array of sources includes an array of semiconductor lasers.
- 11. (original) The maskless lithography system as claimed in claim 8, wherein said array of sources includes an array of vertical cavity surface emitting lasers.
- 12. (original) The maskless lithography system as claimed in claim 8, wherein said array of focusing elements includes an array of diffractive elements.
- 13. (currently amended) A maskless lithography system comprising an array of Fresnel lenses, each of which focuses [an energy] photon beam from an array of photon sources into an array of focal spots on an adjacent substrate in order to create a permanent pattern on [an] the adjacent substrate.
- 14. (canceled)
- 15. (canceled).
- 16. (currently amended) A maskless lithography system comprising an array of photon sieves, each of which focuses [an energy] a photon beam from an array of photon sources into an array of

focal spots <u>on an adjacent substrate</u> in order to create a permanent pattern on [an] <u>the</u> adjacent substrate.